



NSAI
Standards

Irish Standard
I.S. EN 60539-2:2004

Directly heated negative temperature coefficient thermistors -- Part 2:
Sectional specification - Surface mount negative temperature coefficient thermistors (IEC 60539-2:2003 (EQV))

I.S. EN 60539-2:2004

Incorporating amendments/corrigenda issued since publication:
EN 60539-2:2004/A1:2010

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NSAI 1 Swift Square, Northwood, Santry Dublin 9	T +353 1 807 3800 F +353 1 807 3838 E standards@nsai.ie W NSAI.ie	Sales: T +353 1 857 6730 F +353 1 857 6729 W standards.ie
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**Directly heated negative temperature coefficient thermistors -
Part 2: Sectional specification -
Surface mount negative temperature coefficient thermistors
(IEC 60539-2:2003/A1:2010)**

Thermistors à coefficient de température négatif à chauffage direct -
Partie 2: Spécification intermédiaire -
Montage en surface de thermistors à coefficient de température négatif
(CEI 60539-2:2003/A1:2010)

Direkt geheizte temperaturabhängige Widerstände mit negativem Temperaturkoeffizienten -
Teil 2: Rahmenspezifikation -
Oberflächenmontierbare temperaturabhängige Widerstände mit negativem Temperaturkoeffizienten
(IEC 60539-2:2003/A1:2010)

This amendment A1 modifies the European Standard EN 60539-2:2004; it was approved by CENELEC on 2010-09-01. CENELEC members are bound to comply with the CEN/CENELEC Internal Regulations which stipulate the conditions for giving this amendment the status of a national standard without any alteration.

Up-to-date lists and bibliographical references concerning such national standards may be obtained on application to the Central Secretariat or to any CENELEC member.

This amendment exists in three official versions (English, French, German). A version in any other language made by translation under the responsibility of a CENELEC member into its own language and notified to the Central Secretariat has the same status as the official versions.

CENELEC members are the national electrotechnical committees of Austria, Belgium, Bulgaria, Croatia, Cyprus, the Czech Republic, Denmark, Estonia, Finland, France, Germany, Greece, Hungary, Iceland, Ireland, Italy, Latvia, Lithuania, Luxembourg, Malta, the Netherlands, Norway, Poland, Portugal, Romania, Slovakia, Slovenia, Spain, Sweden, Switzerland and the United Kingdom.

CENELEC

European Committee for Electrotechnical Standardization
Comité Européen de Normalisation Electrotechnique
Europäisches Komitee für Elektrotechnische Normung

Management Centre: Avenue Marnix 17, B - 1000 Brussels

Foreword

The text of document 40/2034/CDV, future amendment 1 to IEC 60539-2:2003, prepared by IEC TC 40, Capacitors and resistors for electronic equipment, was submitted to the IEC-CENELEC parallel vote and was approved by CENELEC as amendment A1 to EN 60539-2:2004 on 2010-09-01.

Attention is drawn to the possibility that some of the elements of this document may be the subject of patent rights. CEN and CENELEC shall not be held responsible for identifying any or all such patent rights.

The following dates were fixed:

- latest date by which the amendment has to be implemented at national level by publication of an identical national standard or by endorsement (dop) 2011-06-01
- latest date by which the national standards conflicting with the amendment have to be withdrawn (dow) 2013-09-01

Annex ZA has been added by CENELEC.

Endorsement notice

The text of amendment 1:2010 to the International Standard IEC 60539-2:2003 was approved by CENELEC as an amendment to the European Standard without any modification.

Annex ZA (normative)

Normative references to international publications with their corresponding European publications

The following referenced documents are indispensable for the application of this document. For dated references, only the edition cited applies. For undated references, the latest edition of the referenced document (including any amendments) applies.

NOTE When an international publication has been modified by common modifications, indicated by (mod), the relevant EN/HD applies.

<u>Publication</u>	<u>Year</u>	<u>Title</u>	<u>EN/HD</u>	<u>Year</u>
<i>Replace the reference:</i>				
IEC 60068-2-58	1999	Environmental testing - Part 2-58: Tests - Test Td: Test methods for solderability, resistance to dissolution of metallization and to soldering heat of surface mounting devices (SMD)	EN 60068-2-58	1999
<i>with the following:</i>				
IEC 60068-2-58	2004	Environmental testing - Part 2-58: Tests - Test Td: Test methods for solderability, resistance to dissolution of metallization and to soldering heat of surface mounting devices (SMD)	EN 60068-2-58 + corr. December	2004 2004

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FOREWORD

This amendment has been prepared by IEC technical committee 40: *Capacitors and resistors for electronic equipment*.

The text of this amendment is based on the following documents:

CDV	Report on voting
40/2034/CDV	40/2051/RVC

Full information on the voting for the approval of this amendment can be found in the report on voting indicated in the above table.

The committee has decided that the contents of this amendment and the base publication will remain unchanged until the stability date indicated on the IEC web site under "<http://webstore.iec.ch>" in the data related to the specific publication. At this date, the publication will be

- reconfirmed,
- withdrawn,
- replaced by a revised edition, or
- amended.

1.2 Normative references

Modify the reference to IEC 60068-2-58:1999 as follows:

IEC 60068-2-58:2004, *Environmental testing – Part 2-58: Tests – Test Td: Test methods for solderability, resistance to dissolution of metallization and to soldering heat of surface mounting devices (SMD)*

4.6.2 Test conditions

4.6.2.1 Solder bath method

Replace the text of Subclause 4.6.2.1 by the following new text:

See IEC 60068-2-58, Clauses 6 and 8, if not otherwise specified in the detail specification.

4.6.2.2 Infrared and forced gas convection soldering system

Replace the title and the text of Subclause 4.6.2.2 by the following new title and text:

4.6.2.2 Reflow method

See IEC 60068-2-58, Clauses 7 and 8, if not otherwise specified in the detail specification.

4.7.1 Test conditions

4.7.1.1 Solder bath method

Replace the text of Subclause 4.7.1.1 by the following new text:

See IEC 60068-2-58, Clauses 6 and 8, if not otherwise specified in the detail specification.

4.7.1.2 Infrared and forced gas convection soldering system

Replace the title and the text of Subclause 4.7.1.2 by the following new title and text:

4.7.1.2 Reflow method

See IEC 60068-2-58, Clauses 7 and 8, if not otherwise specified in the detail specification.

EUROPEAN STANDARD

EN 60539-2

NORME EUROPÉENNE

EUROPÄISCHE NORM

February 2004

ICS 31.040.30

English version

**Directly heated negative temperature coefficient thermistors
Part 2: Sectional specification -
Surface mount negative temperature coefficient thermistors
(IEC 60539-2:2003)**

Thermistors à coefficient de température négatif à chauffage direct
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Teil 2: Rahmenspezifikation -
Oberflächenmontierbare temperaturabhängige Widerstände mit negativem Temperaturkoeffizienten
(IEC 60539-2:2003)

This European Standard was approved by CENELEC on 2004-02-01. CENELEC members are bound to comply with the CEN/CENELEC Internal Regulations which stipulate the conditions for giving this European Standard the status of a national standard without any alteration.

Up-to-date lists and bibliographical references concerning such national standards may be obtained on application to the Central Secretariat or to any CENELEC member.

This European Standard exists in three official versions (English, French, German). A version in any other language made by translation under the responsibility of a CENELEC member into its own language and notified to the Central Secretariat has the same status as the official versions.

CENELEC members are the national electrotechnical committees of Austria, Belgium, Cyprus, Czech Republic, Denmark, Estonia, Finland, France, Germany, Greece, Hungary, Iceland, Ireland, Italy, Latvia, Lithuania, Luxembourg, Malta, Netherlands, Norway, Poland, Portugal, Slovakia, Slovenia, Spain, Sweden, Switzerland and United Kingdom.

CENELEC

European Committee for Electrotechnical Standardization
Comité Européen de Normalisation Electrotechnique
Europäisches Komitee für Elektrotechnische Normung

Central Secretariat: rue de Stassart 35, B - 1050 Brussels

I.S. EN 60539-2:2004

EN 60539-2:2004

- 2 -

Foreword

The text of document 40/1346/FDIS, future edition 1 of IEC 60539-2, prepared by IEC TC 40, Capacitors and resistors for electronic equipment, was submitted to the IEC-CENELEC parallel vote and was approved by CENELEC as EN 60539-2 on 2004-02-01.

The following dates were fixed:

- latest date by which the EN has to be implemented
at national level by publication of an identical
national standard or by endorsement (dop) 2004-11-01
- latest date by which the national standards conflicting
with the EN have to be withdrawn (dow) 2007-02-01

Annex ZA has been added by CENELEC.

Endorsement notice

The text of the International Standard IEC 60539-2:2003 was approved by CENELEC as a European Standard without any modification.

Annex ZA (normative)

Normative references to international publications with their corresponding European publications

The following referenced documents are indispensable for the application of this document. For dated references, only the edition cited applies. For undated references, the latest edition of the referenced document (including any amendments) applies.

NOTE When an international publication has been modified by common modifications, indicated by (mod), the relevant EN/HD applies.

<u>Publication</u>	<u>Year</u>	<u>Title</u>	<u>EN/HD</u>	<u>Year</u>
IEC 60068-2-2	1974	Basic environmental testing procedures Part 2: Tests - Tests B: Dry heat	EN 60068-2-2 ¹⁾	1993
A1	1993		A1	1993
A2	1994		A2	1994
IEC 60068-2-14	1984	Part 2: Tests - Test N: Change of temperature		
+ A1	1986		EN 60068-2-14	1999
IEC 60068-2-30	1980	Part 2: Tests - Test Db and guidance: Damp heat, cyclic (12 + 12 hour cycle)		
+ A1	1985		EN 60068-2-30	1999
IEC 60068-2-58	1999	Part 2-58: Tests - Test Td: Test methods for solderability, resistance to dissolution of metallization and to soldering heat of surface mounting devices (SMD)	EN 60068-2-58	1999
IEC 60068-2-78	- 2)	Part 2-78: Tests - Test Cab: Damp heat, steady state	EN 60068-2-78	2001 ³⁾
IEC 60410	1973	Sampling plans and procedures for inspection by attributes	-	-
IEC 60539-1	2002	Directly heated negative temperature coefficient thermistors Part 1: Generic specification	EN 60539-1	2002

1) EN 60068-2-2 includes supplement A:1976 to IEC 60068-2-2.

2) Undated reference.

3) Valid edition at date of issue.

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CONTENTS

FOREWORD.....	4
1 General.....	6
1.1 Scope.....	6
1.2 Normative references.....	6
1.3 Information to be given in a detail specification.....	6
1.3.1 Outline drawing and dimensions.....	7
1.3.2 Mounting.....	7
1.3.3 Ratings and characteristics.....	7
1.4 Terminology.....	7
2 Preferred ratings and characteristics.....	7
2.1 Tolerances on rated zero-power resistance.....	7
2.2 Climatic categories.....	7
3 Quality assessment procedures.....	8
3.1 Primary stage of manufacture.....	8
3.2 Structurally similar components.....	8
3.3 Qualification approval procedures.....	8
3.3.1 The manufacturer shall comply with 3.4 of IEC 60539-1.....	8
3.4 Quality conformance inspection.....	8
3.4.1 Qualification approval on the basis of the fixed sample size procedure.....	8
3.5 Quality conformance inspection.....	10
3.5.1 Formation of inspection lots.....	10
3.5.2 Test schedule.....	11
3.5.3 Delayed delivery.....	11
3.5.4 Assessment level.....	11
4 Test and measurement procedures.....	12
4.1 Mounting.....	12
4.2 Drying and recovery.....	12
4.2.1 Drying.....	12
4.2.2 Recovery.....	12
4.3 Visual examination and check of dimensions.....	12
4.3.1 Visual examination.....	12
4.3.2 Requirements.....	12
4.3.3 Marking.....	14
4.3.4 Dimensions.....	14
4.4 Electrical tests.....	14
4.4.1 Zero-power resistance.....	14
4.4.2 <i>B</i> -value or resistance ratio.....	14
4.4.3 Resistance/temperature characteristic.....	15
4.5 Thermal tests.....	15
4.5.1 Dissipation factor (δ).....	15
4.5.2 Thermal time constant by cooling after self-heating (τ_c).....	15
4.6 Resistance to soldering heat.....	15
4.6.1 Initial measurement.....	15
4.6.2 Test conditions.....	15
4.6.3 Recovery.....	16

4.6.4	Final inspection, measurements and requirements	16
4.7	Solderability	16
4.7.1	Test conditions	16
4.7.2	Recovery	17
4.7.3	Final inspection, measurements and requirements	17
4.8	Rapid change of temperature	17
4.9	Thermal shock.....	17
4.10	Climatic sequence	18
4.10.1	Initial measurements	18
4.10.2	Dry heat	18
4.10.3	Damp heat (cyclic), first cycle	18
4.10.4	Cold	18
4.10.5	Damp heat (cyclic), remaining cycles.....	18
4.10.6	Final measurements	19
4.11	Damp heat, steady state.....	19
4.12	Endurance.....	19
4.12.1	Endurance at θ_3 and P_{max}	19
4.12.2	Endurance at upper category temperature	19
4.13	Shear (adhesion) test	20
4.14	Substrate bending test	20
4.15	Component solvent resistance.....	20
4.16	Solvent resistance of marking.....	20
Annex A (normative) Guide for the specification and coding of dimensions of surface mount negative temperature coefficient thermistors		21
Figure 1	– Fault: fissure or defect	13
Figure 2	– Fault: crack	13
Figure 3	– Separation or delamination	13
Figure 4	– Exposed electrodes.....	13
Figure 5	– Principal faces	14
Figure A.1	– Dimensioning of surface mount thermistors.....	21
Table 1	– Upper and lower category temperatures and duration of the damp heat test.....	8
Table 2	– Fixed sample size test schedule for qualification approval of surface mount negative temperature coefficient thermistors Assessment level EZ	10
Table 3	– Lot-by-lot inspection	11
Table 4	– Periodic test	12
Table 5	– Number of cycles	18
Table A.1	– Dimensions	21

INTERNATIONAL ELECTROTECHNICAL COMMISSION

**DIRECTLY HEATED NEGATIVE TEMPERATURE
COEFFICIENT THERMISTORS –****Part 2: Sectional specification –
Surface mount negative temperature coefficient thermistors**

FOREWORD

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International Standard IEC 60539-2 has been prepared by IEC technical committee 40: Capacitors and resistors for electronic equipment.

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FDIS	Report on voting
40/1346/FDIS	40/1368/RVD

Full information on the voting for the approval of this standard can be found in the report on voting indicated in the above table.

The French version of this standard has not been voted upon.

This publication has been drafted in accordance with the ISO/IEC Directives, Part 2.

The committee has decided that the contents of this publication will remain unchanged until the stability date indicated on the IEC web site under "<http://webstore.iec.ch>" in the data related to the specific publication. At this date, the publication will be

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